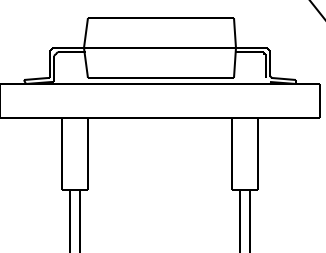
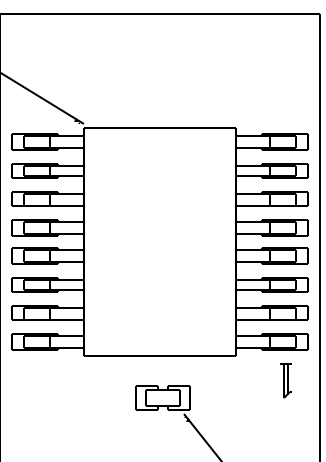
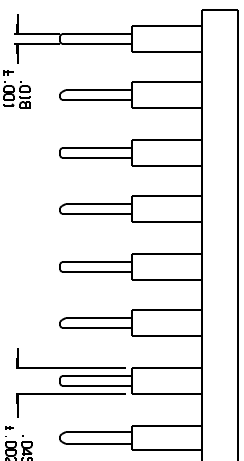
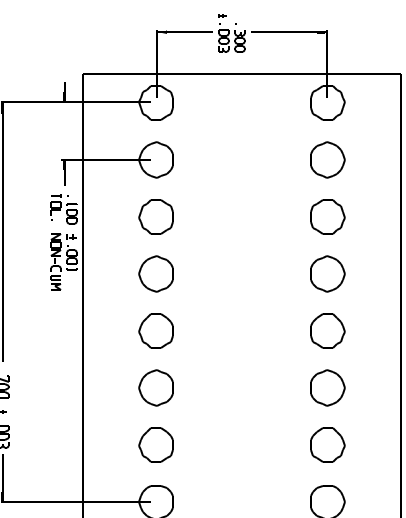
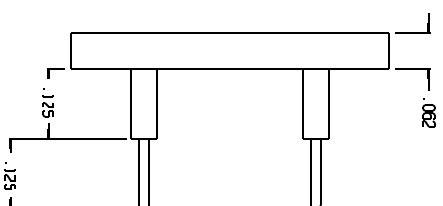
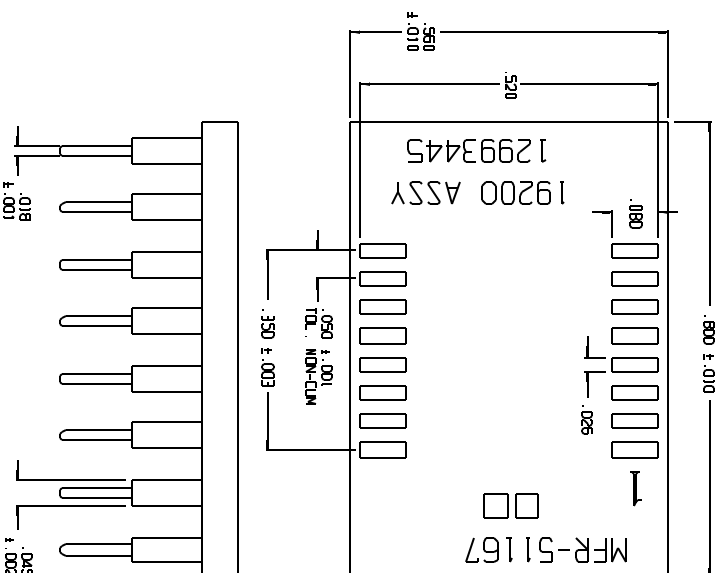


DRAWING NO.

7750-122-18-B

REV:	ECN NO.	DATE:	APP:
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1	PRELIM.	7/21/05	JW
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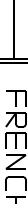


FORMED LEAD IC
#SNJ54123M

— 603 RESISTER
CRLWD603321FRT

- NOTE:
1. BOARD MATERIAL: .062 FR-4 PER IPC-4101/21
 2. PIN MATERIAL: BRASS ALLOY 360, 1/2 HARD PER ASTM-B121.
 3. PIN PLATING: 200u" MIN. TIN/LEAD PER ASTM B645 OVER 100u" MIN. NICKEL PER SAE AMS-DD-N-290.

INCH OR INCH (MM)		TOLERANCES UNLESS OTHERWISE SPECIFIED		MATERIAL: SEE NOTES	
0.0		± .03		USED ON:	
0.00		± .015		DES: ☐	
0.000		± .005		DRW: JAH 7/21/05	
ANGLES ± 2°		MOLD NO.		OKD: ☐	
				APP: ☐	
THIRD ANGLE PROJECTION					
					

 PARIES[®] ELECTRONICS, INC. FRENCHTOWN, N.J. 08825		SCALE: 1:1	TITLE: 16 PIN FORMED LEAD FLAT PACK
SHEET 1 OF 1	SIZE AS	DRAWING NO. 7750-122-18-B	REV 2